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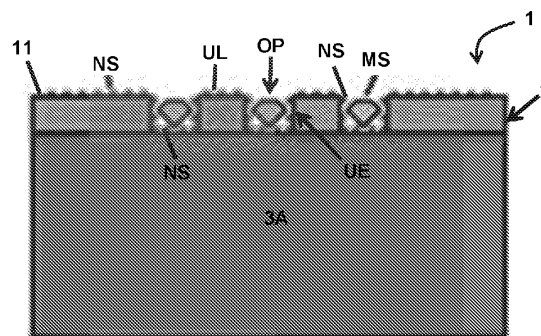


Figure 1E

(57) Abstract: The present invention concerns a diamond device or structure comprising at least one supporting layer or material including at least one or a plurality of support structures inside the at least one supporting layer or material; a plurality of recesses defined by the at least one or the plurality of support structures; and at least one diamond micro-seed and a plurality of diamond nano-seeds located in each recess or in the plurality of recesses.



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